

OVERVIEW

The SM5073 series are VCXO ICs with built-in varicap diode. They use a recently developed negative-resistance switching oscillation circuit, at oscillation startup and during normal oscillation, for both good oscillation startup characteristics and wide pullrange. Furthermore, it employs a CMOS process varicap diode, and also features all the necessary VCXO structure circuit components on a single chip, forming a VCXO with just the connection of an external crystal.

FEATURES

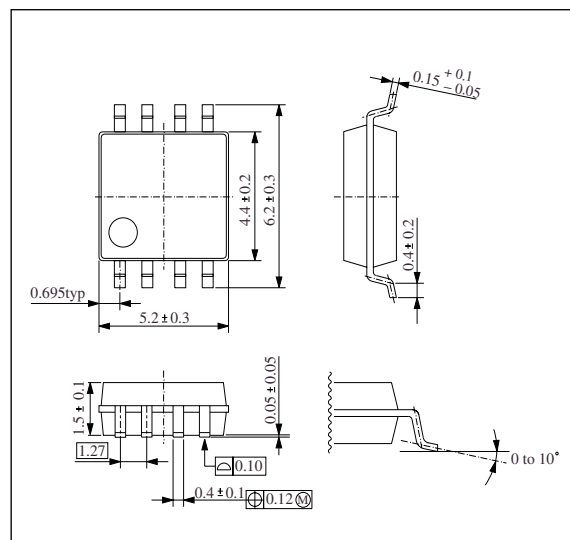
- 3.0 to 3.6V supply voltage range
- 10MHz to 60MHz operating frequency (varies with version)
- Uses negative-resistance switching function
- Varicap diode built-in
- Frequency divider built-in (varies with version: f_O , $f_O/2$, $f_O/4$, $f_O/8$, $f_O/16$, $f_O/32$)
- CMOS output level
- $50 \pm 10\%$ output duty
- 6mA (min) output drive capability
- 15pF output load capacitance C_L
- Standby function
High impedance in standby mode (oscillator continues running)
- Package: 8-pin SOP (SM5073××S)

APPLICATIONS

- VCXO modules
- Communications application
- Networking application
- Broadcasting application

PACKAGE DIMENSIONS

(Unit: mm)



SERIES LINEUP

Version	Typical oscillation frequency ¹ [MHz]	Output frequency					
		SM5073×1S	SM5073×2S ²	SM5073×3S ²	SM5073×4S ²	SM5073×5S ²	SM5073×6S ²
SM5073A×S	16	f_O	$f_O/2$	$f_O/4$	$f_O/8$	$f_O/16$	$f_O/32$
SM5073B×S	23						
SM5073C×S	30						
SM5073D×S	37						
SM5073E×S	44						
SM5073F×S	51						

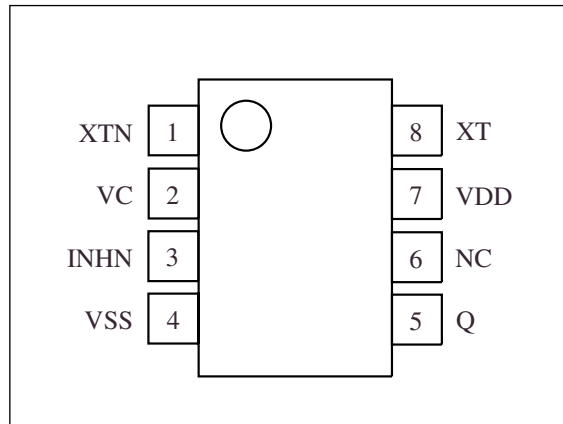
1. The typical oscillation frequency is the oscillation frequency criteria for use when selecting the device version. Note that the oscillation characteristics and pullability vary with the crystal used and the mounting conditions. Even for the same frequency, the optimal version can vary with crystal characteristics, so careful evaluation should be exercised when selecting the device version.
 2. These versions are produced after receiving a purchase order. Please ask our Sales & Marketing section for further detail.

ORDERING INFORMATION

Device	Package
SM5073××S	8-pin SOP

PINOUT

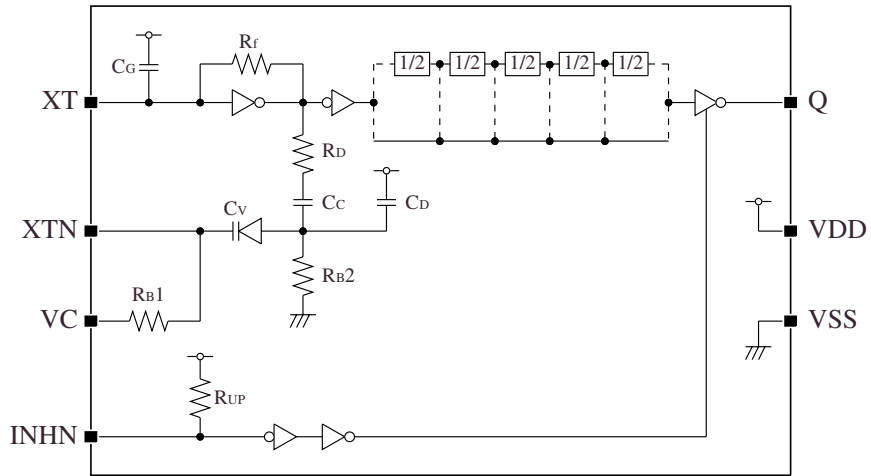
(Top view)



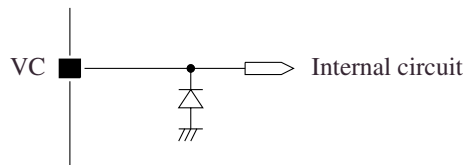
PIN DESCRIPTION

Number	Name	I/O	Description	Function
1	XTN	O	Amplifier output pin	Crystal connection pins. Crystal is connected between XT and XTN.
2	VC	I	Oscillation frequency control voltage input pin	Positive polarity (frequency increases with increasing voltage)
3	INH	I	Output state control voltage input pin	High-impedance output when LOW, pull-up resistor built-in
4	VSS	-	(-) supply pin	
5	Q	O	Output pin	Output frequency determined by internal circuit to one of f_0 , $f_0/2$, $f_0/4$, $f_0/8$, $f_0/16$, $f_0/32$
6	NC	-	No connection	
7	VDD	-	(+) supply pin	
8	XT	I	Amplifier input pin	Crystal connection pins. Crystal is connected between XT and XTN.

BLOCK DIAGRAM



Note. ESD of XT pin is inferior to other pins.
 ESD of all pins excluding XT pin is equivalent to that of our other oscillator products.
 VC pin has no protection circuit at V_{DD} side. (See figure below.)



ABSOLUTE MAXIMUM RATINGS

$V_{SS} = 0V$ unless otherwise noted.

Parameter	Symbol	Conditions	Rating	Unit
Supply voltage range	V_{DD}		-0.5 to 7.0	V
Input voltage range	V_{IN}	All input pins excluding VC pin	-0.5 to $V_{DD} + 0.5$	V
		VC pin	-0.5 to $V_{DD} + 2.5^1$	V
Output voltage range	V_{OUT}		-0.5 to $V_{DD} + 0.5$	V
Operating temperature range	T_{opr}		-40 to +85	°C
Storage temperature range	T_{STG}		-55 to +125	°C
Output current	I_{OUT}		20	mA
Power dissipation	P_D		500	mW

1. It should not exceed +7.0V.

RECOMMENDED OPERATING CONDITIONS

$V_{SS} = 0V$, $f = 10MHz$ to $60MHz$, $C_L \leq 15pF$ unless otherwise noted.

Parameter	Symbol	Conditions	Rating			Unit
			Min	Typ	Max	
Operating supply voltage	V_{DD}		3.0	-	3.6	V
Input voltage	V_{IN}		V_{SS}	-	V_{DD}	V
Operating temperature	T_{OPR}		-40	-	+85	°C

ELECTRICAL CHARACTERISTICS

SM5073A×S

$V_{DD} = 3.0$ to $3.6V$, $V_C = 1.65V$, $V_{SS} = 0V$, $T_a = -40$ to $+85^\circ C$, unless otherwise noted.

Parameter	Symbol	Conditions	Rating			Unit	
			Min	Typ	Max		
HIGH-level output voltage	V_{OH}	Q: Measurement circuit 1, $I_{OH} = 6mA$	2.5	2.75	–	V	
LOW-level output voltage	V_{OL}	Q: Measurement circuit 1, $I_{OL} = 6mA$	–	0.2	0.4	V	
Output leakage current	I_Z	Q: Measurement circuit 6, INHN = LOW	$V_{OH} = V_{DD}$	–	–	10	μA
			$V_{OL} = V_{SS}$	–	–	10	μA
HIGH-level input voltage	V_{IH}	INHN	$0.7V_{DD}$	–	–	V	
LOW-level input voltage	V_{IL}	INHN	–	–	$0.3V_{DD}$	V	
Current consumption	I_{DD}	Measurement circuit 2, load circuit 1, INHN = open, $C_L = 15pF$, $f = 16MHz$	SM5073A1S	–	8	23	mA
			SM5073A2S	–	7.5	22.5	mA
			SM5073A3S	–	7	22	mA
			SM5073A4S to 6S	–	7	22	mA
INHN pull-up resistance	R_{UP}	Measurement circuit 3	50	100	180	$k\Omega$	
Built-in resistance	R_f	Design value. A monitor pattern on a wafer is tested.	150	300	540	$k\Omega$	
	R_D		0.67	0.96	1.25	$k\Omega$	
	R_{B1}	Measurement circuit 4	100	200	360	$k\Omega$	
	R_{B2}	Design value. A monitor pattern on a wafer is tested.	50	100	180	$k\Omega$	
Built-in capacitance	C_V	Design value. A monitor pattern on a wafer is tested.	$V_C = 0.3V$	11.0	14.4	17.8	pF
			$V_C = 3.0V$	2.4	4.0	5.6	pF
	C_G	Design value. A monitor pattern on a wafer is tested.	25.5	30	34.5	pF	
	C_D		34	40	46	pF	
	C_C		8.5	10	11.5	pF	

SM5073 series

SM5073B×S

$V_{DD} = 3.0$ to $3.6V$, $V_C = 1.65V$, $V_{SS} = 0V$, $T_a = -40$ to $+85^\circ C$, unless otherwise noted.

Parameter	Symbol	Conditions	Rating			Unit	
			Min	Typ	Max		
HIGH-level output voltage	V_{OH}	Q: Measurement circuit 1, $I_{OH} = 6mA$	2.5	2.75	–	V	
LOW-level output voltage	V_{OL}	Q: Measurement circuit 1, $I_{OL} = 6mA$	–	0.2	0.4	V	
Output leakage current	I_Z	Q: Measurement circuit 6, INHN = LOW	$V_{OH} = V_{DD}$	–	–	10	μA
			$V_{OL} = V_{SS}$	–	–	10	μA
HIGH-level input voltage	V_{IH}	INHN	$0.7V_{DD}$	–	–	V	
LOW-level input voltage	V_{IL}	INHN	–	–	$0.3V_{DD}$	V	
Current consumption	I_{DD}	Measurement circuit 2, load circuit 1, INHN = open, $C_L = 15pF$, $f = 23MHz$	SM5073B1S	–	9	25	mA
			SM5073B2S	–	8	24	mA
			SM5073B3S	–	7.5	23.5	mA
			SM5073B4S to 6S	–	7.5	23.5	mA
INHN pull-up resistance	R_{UP}	Measurement circuit 3	50	100	180	$k\Omega$	
Built-in resistance	R_f	Design value. A monitor pattern on a wafer is tested.	150	300	540	$k\Omega$	
	R_D		0.50	0.72	0.94	$k\Omega$	
	R_{B1}	Measurement circuit 4	100	200	360	$k\Omega$	
	R_{B2}	Design value. A monitor pattern on a wafer is tested.	50	100	180	$k\Omega$	
Built-in capacitance	C_V	Design value. A monitor pattern on a wafer is tested.	$V_C = 0.3V$	11.0	14.6	18.2	pF
			$V_C = 3.0V$	2.3	4.0	5.7	pF
	C_G	Design value. A monitor pattern on a wafer is tested.	25.5	30	34.5	pF	
	C_D		34	40	46	pF	
	C_C		12.7	15	17.3	pF	

SM5073 series

SM5073C×S

$V_{DD} = 3.0$ to $3.6V$, $V_C = 1.65V$, $V_{SS} = 0V$, $T_a = -40$ to $+85^\circ C$, unless otherwise noted.

Parameter	Symbol	Conditions	Rating			Unit	
			Min	Typ	Max		
HIGH-level output voltage	V_{OH}	Q: Measurement circuit 1, $I_{OH} = 6mA$	2.5	2.75	–	V	
LOW-level output voltage	V_{OL}	Q: Measurement circuit 1, $I_{OL} = 6mA$	–	0.2	0.4	V	
Output leakage current	I_Z	Q: Measurement circuit 6, INHN = LOW	$V_{OH} = V_{DD}$	–	–	10	μA
			$V_{OL} = V_{SS}$	–	–	10	μA
HIGH-level input voltage	V_{IH}	INHN	$0.7V_{DD}$	–	–	V	
LOW-level input voltage	V_{IL}	INHN	–	–	$0.3V_{DD}$	V	
Current consumption	I_{DD}	Measurement circuit 2, load circuit 1, INHN = open, $C_L = 15pF$, $f = 30MHz$	SM5073C1S	–	10	28	mA
			SM5073C2S	–	9	27	mA
			SM5073C3S	–	8.5	26.5	mA
			SM5073C4S to 6S	–	8	26	mA
INHN pull-up resistance	R_{UP}	Measurement circuit 3	50	100	180	$k\Omega$	
Built-in resistance	R_f	Design value. A monitor pattern on a wafer is tested.	150	300	540	$k\Omega$	
	R_D		0.50	0.72	0.94	$k\Omega$	
	R_{B1}	Measurement circuit 4	100	200	360	$k\Omega$	
	R_{B2}	Design value. A monitor pattern on a wafer is tested.	50	100	180	$k\Omega$	
Built-in capacitance	C_V	Design value. A monitor pattern on a wafer is tested.	$V_C = 0.3V$	11.0	14.6	18.2	pF
			$V_C = 3.0V$	2.3	4.0	5.7	pF
	C_G	Design value. A monitor pattern on a wafer is tested.	25.5	30	34.5	pF	
	C_D		25.5	30	34.5	pF	
	C_C		29.7	35	40.3	pF	

SM5073 series

SM5073D×S

$V_{DD} = 3.0$ to $3.6V$, $V_C = 1.65V$, $V_{SS} = 0V$, $T_a = -40$ to $+85^\circ C$, unless otherwise noted.

Parameter	Symbol	Conditions	Rating			Unit	
			Min	Typ	Max		
HIGH-level output voltage	V_{OH}	Q: Measurement circuit 1, $I_{OH} = 6mA$	2.5	2.75	–	V	
LOW-level output voltage	V_{OL}	Q: Measurement circuit 1, $I_{OL} = 6mA$	–	0.2	0.4	V	
Output leakage current	I_Z	Q: Measurement circuit 6, INHN = LOW	$V_{OH} = V_{DD}$	–	–	10	μA
			$V_{OL} = V_{SS}$	–	–	10	μA
HIGH-level input voltage	V_{IH}	INHN	$0.7V_{DD}$	–	–	V	
LOW-level input voltage	V_{IL}	INHN	–	–	$0.3V_{DD}$	V	
Current consumption	I_{DD}	Measurement circuit 2, load circuit 1, INHN = open, $C_L = 15pF$, $f = 37MHz$	SM5073D1S	–	11	30	mA
			SM5073D2S	–	9.5	28.5	mA
			SM5073D3S	–	9	28	mA
			SM5073D4S to 6S	–	8.5	27.5	mA
INHN pull-up resistance	R_{UP}	Measurement circuit 3	50	100	180	$k\Omega$	
Built-in resistance	R_f	Design value. A monitor pattern on a wafer is tested.	150	300	540	$k\Omega$	
	R_D		0.25	0.36	0.47	$k\Omega$	
	R_{B1}	Measurement circuit 4	100	200	360	$k\Omega$	
	R_{B2}	Design value. A monitor pattern on a wafer is tested.	50	100	180	$k\Omega$	
Built-in capacitance	C_V	Design value. A monitor pattern on a wafer is tested.	$V_C = 0.3V$	11.0	14.6	18.2	pF
			$V_C = 3.0V$	2.3	4.0	5.7	pF
	C_G	Design value. A monitor pattern on a wafer is tested.	25.5	30	34.5	pF	
	C_D		25.5	30	34.5	pF	
	C_C		34	40	46	pF	

SM5073 series

SM5073E×S

$V_{DD} = 3.0$ to $3.6V$, $V_C = 1.65V$, $V_{SS} = 0V$, $T_a = -40$ to $+85^\circ C$, unless otherwise noted.

Parameter	Symbol	Conditions	Rating			Unit	
			Min	Typ	Max		
HIGH-level output voltage	V_{OH}	Q: Measurement circuit 1, $I_{OH} = 6mA$	2.5	2.75	–	V	
LOW-level output voltage	V_{OL}	Q: Measurement circuit 1, $I_{OL} = 6mA$	–	0.2	0.4	V	
Output leakage current	I_Z	Q: Measurement circuit 6, INHN = LOW	$V_{OH} = V_{DD}$	–	–	10	μA
			$V_{OL} = V_{SS}$	–	–	10	μA
HIGH-level input voltage	V_{IH}	INHN	$0.7V_{DD}$	–	–	V	
LOW-level input voltage	V_{IL}	INHN	–	–	$0.3V_{DD}$	V	
Current consumption	I_{DD}	Measurement circuit 2, load circuit 1, INHN = open, $C_L = 15pF$, $f = 44MHz$	SM5073E1S	–	12	32	mA
			SM5073E2S	–	10.5	30.5	mA
			SM5073E3S	–	9.5	29.5	mA
			SM5073E4S to 6S	–	9	29	mA
INHN pull-up resistance	R_{UP}	Measurement circuit 3	50	100	180	$k\Omega$	
Built-in resistance	R_f	Design value. A monitor pattern on a wafer is tested.	150	300	540	$k\Omega$	
	R_D		0.25	0.36	0.47	$k\Omega$	
	R_{B1}	Measurement circuit 4	100	200	360	$k\Omega$	
	R_{B2}	Design value. A monitor pattern on a wafer is tested.	50	100	180	$k\Omega$	
Built-in capacitance	C_V	Design value. A monitor pattern on a wafer is tested.	$V_C = 0.3V$	11.0	14.6	18.2	pF
			$V_C = 3.0V$	2.3	4.0	5.7	pF
	C_G	Design value. A monitor pattern on a wafer is tested.	21.2	25	28.8	pF	
	C_D		21.2	25	28.8	pF	
	C_C		42.5	50	57.5	pF	

SM5073 series

SM5073F×S

$V_{DD} = 3.0$ to $3.6V$, $V_C = 1.65V$, $V_{SS} = 0V$, $T_a = -40$ to $+85^\circ C$, unless otherwise noted.

Parameter	Symbol	Conditions	Rating			Unit	
			Min	Typ	Max		
HIGH-level output voltage	V_{OH}	Q: Measurement circuit 1, $I_{OH} = 6mA$	2.5	2.75	–	V	
LOW-level output voltage	V_{OL}	Q: Measurement circuit 1, $I_{OL} = 6mA$	–	0.2	0.4	V	
Output leakage current	I_Z	Q: Measurement circuit 6, INHN = LOW	$V_{OH} = V_{DD}$	–	–	10	μA
			$V_{OL} = V_{SS}$	–	–	10	μA
HIGH-level input voltage	V_{IH}	INHN	$0.7V_{DD}$	–	–	V	
LOW-level input voltage	V_{IL}	INHN	–	–	$0.3V_{DD}$	V	
Current consumption	I_{DD}	Measurement circuit 2, load circuit 1, INHN = open, $C_L = 15pF$, $f = 51MHz$	SM5073F1S	–	13	35	mA
			SM5073F2S	–	11	33	mA
			SM5073F3S	–	10	32	mA
			SM5073F4S to 6S	–	9.5	31.5	mA
INHN pull-up resistance	R_{UP}	Measurement circuit 3	50	100	180	$k\Omega$	
Built-in resistance	R_f	Design value. A monitor pattern on a wafer is tested.	150	300	540	$k\Omega$	
	R_D		0.25	0.36	0.47	$k\Omega$	
	R_{B1}	Measurement circuit 4	100	200	360	$k\Omega$	
	R_{B2}	Design value. A monitor pattern on a wafer is tested.	50	100	180	$k\Omega$	
Built-in capacitance	C_V	Design value. A monitor pattern on a wafer is tested.	$V_C = 0.3V$	9.5	12.5	15.5	pF
			$V_C = 3.0V$	2.0	3.5	5.0	pF
	C_G	Design value. A monitor pattern on a wafer is tested.	17	20	23	pF	
	C_D		17	20	23	pF	
	C_C		42.5	50	57.5	pF	

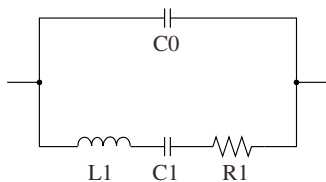
SWITCHING CHARACTERISTICS

$V_{DD} = 3.0$ to $3.6V$, $V_C = 1.65V$, $V_{SS} = 0V$, $T_a = -40$ to $+85^\circ C$, unless otherwise noted

Parameter	Symbol	Conditions	Rating ¹			Unit
			Min	Typ	Max	
Output rise time	t_{r1}	Measurement circuit 2, load circuit 1, $0.1V_{DD} \rightarrow 0.9V_{DD}$, $C_L = 15pF$	–	2.5	6	ns
Output fall time	t_{f1}	Measurement circuit 2, load circuit 1, $0.9V_{DD} \rightarrow 0.1V_{DD}$, $C_L = 15pF$	–	2.5	6	ns
Output duty cycle	Duty	Measurement circuit 2, load circuit 1, $V_{DD} = 3.3V$, $T_a = 25^\circ C$, $C_L = 15pF$	40	50	60	%
Output disable delay time	t_{PLZ}	Measurement circuit 5, load circuit 1, $V_{DD} = 3.3V$, $T_a = 25^\circ C$, $C_L \leq 15pF$	–	–	100	ns
Output enable delay time	t_{PZL}		–	–	100	ns

1. The switching characteristics apply for normal output waveforms. Note that, depending on the matching of the SM5073 series version and crystal, normal waveform output may not be continuous.

Current consumption and Output waveform with NPC's standard crystal



f [MHz]	R1 [Ω]	L1 [mH]	C1 [fF]	C0 [pF]
30	7.06	2.25	12.5	3.11

FUNCTIONAL DESCRIPTION

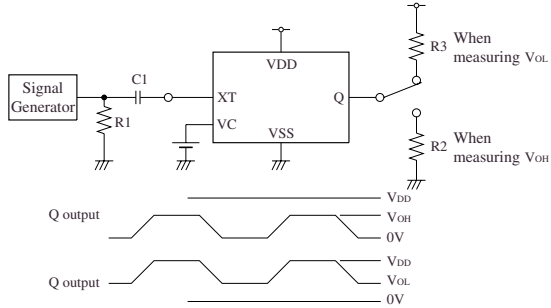
Standby Function

When INHN goes LOW, the Q output pin becomes high impedance.

INHN	Q	Oscillator
HIGH (or open)	Any f_O , $f_O/2$, $f_O/4$, $f_O/8$, $f_O/16$, or $f_O/32$	Operating
LOW	High impedance	Operating

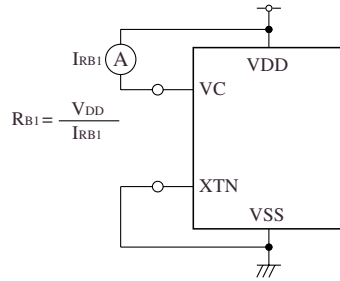
MEASUREMENT CIRCUITS

Measurement Circuit 1

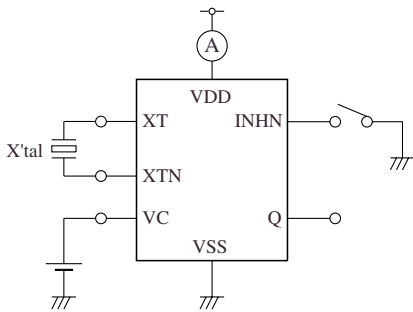


XT input signal: 2.5Vp-p, 10MHz, sine wave
 C1 = 0.001μF, R1 = 50Ω, R2 = 417Ω, R3 = 434Ω, V_C = 1.65V

Measurement Circuit 4

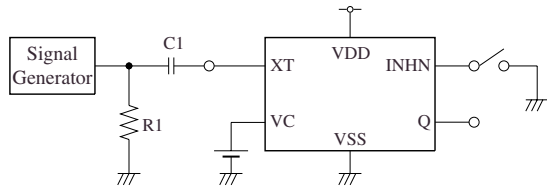


Measurement Circuit 2



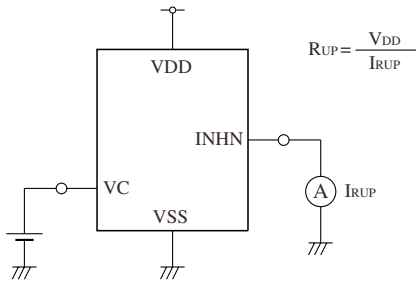
V_C = 1.65V, INHN = open, crystal oscillation

Measurement Circuit 5



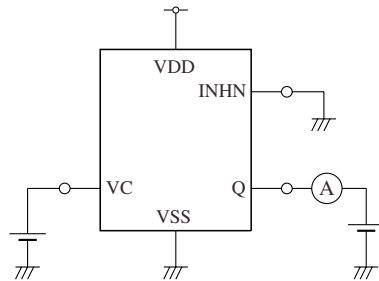
XT input signal: 2.5Vp-p, 10MHz, sine wave
 C1 = 0.001μF, R1 = 50Ω, V_C = 1.65V

Measurement Circuit 3



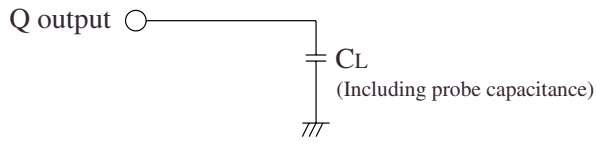
V_C = 1.65V

Measurement Circuit 6



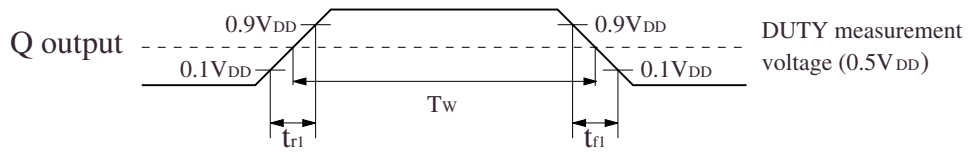
V_C = 1.65V

Load Circuit 1

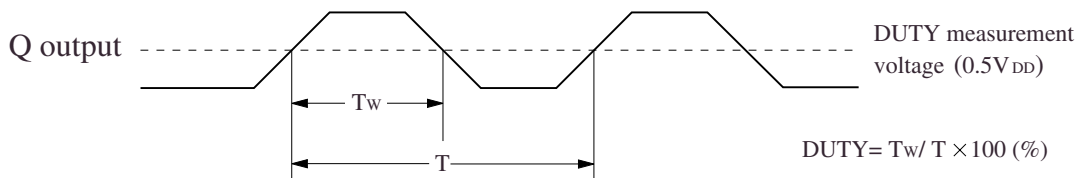


Switching Time Measurement Waveform

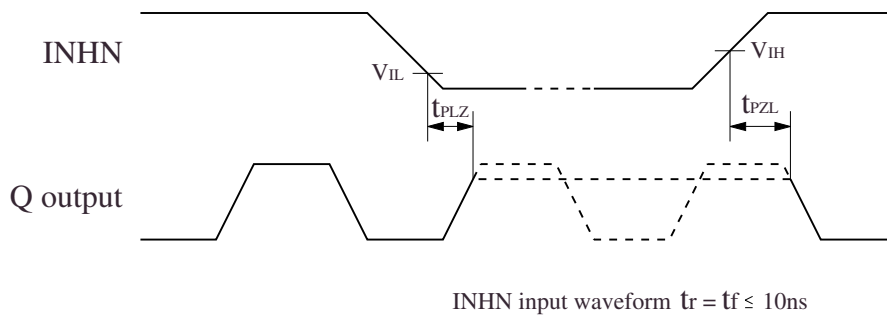
Output duty level, t_r , t_f



Output duty cycle



Output Enable/Disable Delay Times



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